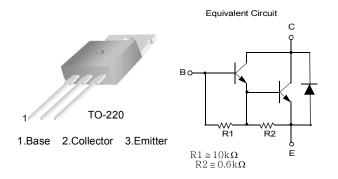


November 2008

TIP110/TIP111/TIP112 NPN Epitaxial Silicon Darlington Transistor

- · Monolithic Construction With Built In Base-Emitter Shunt Resistors
- Complementary to TIP115/116/117
- High DC Current Gain : h_{FE} =1000 @ V_{CE} =4V, I_{C} =1A(Min.)
- Low Collector-Emitter Saturation Voltage
- Industrial Use



Absolute Maximum Ratings* T_a = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{CBO}	Collector-Base Voltage : TIP110	60	V
	: TIP111	80	V
	: TIP112	100	V
	Collector-Emitter Voltage : TIP110	60	V
V _{CEO}	: TIP111	80	V
	: TIP112	100	V
V _{EBO}	Emitter-Base Voltage	5	V
I _C	Collector Current (DC)	2	Α
I _{CP}	Collector Current (Pulse)	4	Α
I _B	Base Current (DC)	50	mA
P _C	Collector Dissipation (T _a =25°C)	2	W
	Collector Dissipation (T _C =25°C)	50	W
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	- 65 ~ 150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

$\textbf{Electrical Characteristics*} \ \, \textbf{T}_{a} = 25^{\circ}\textbf{C} \ \, \textbf{unless otherwise noted}$

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V _{CEO} (sus)	Collector-Emitter Sustaining Voltage : TIP110 : TIP111 : TIP112	I _C = 30mA, I _B = 0	60 80 100			V V V
I _{CEO}	Collector Cut-off Current : TIP110 : TIP111 : TIP112	$V_{CE} = 30V, I_{B} = 0$ $V_{CE} = 40V, I_{B} = 0$ $V_{CE} = 50V, I_{B} = 0$			2 2 2	mA mA mA
I _{CBO}	Collector Cut-off Current : TIP110 : TIP111 : TIP112	$V_{CB} = 60V, I_E = 0$ $V_{CB} = 80V, I_E = 0$ $V_{CB} = 100V, I_E = 0$			1 1 1	mA mA mA
I _{EBO}	Emitter Cut-off Current	$V_{BE} = 5V, I_{C} = 0$			2	mA
h _{FE}	DC Current Gain	V _{CE} = 4V, I _C = 1A V _{CE} = 4V, I _C = 2A	1000 500			
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_{\rm C}$ = 2A, $I_{\rm B}$ = 8mA			2.5	V
V _{BE} (on)	Base-Emitter On Voltage	$V_{CE} = 4V, I_{C} = 2A$			2.8	V
C _{ob}	Output Capacitance	V _{CB} = 10V, I _E = 0, f = 0.1MHz			100	pF

^{*} Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%

Typical Characteristics

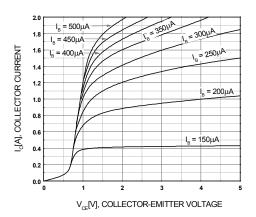


Figure 1. Static Characteristic

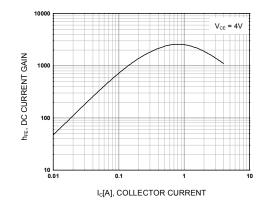


Figure 2. DC current Gain

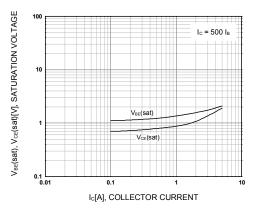


Figure 3. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

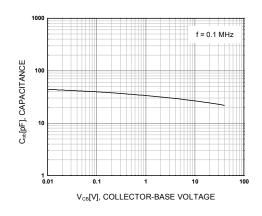


Figure 4. Collector Output Capacitance

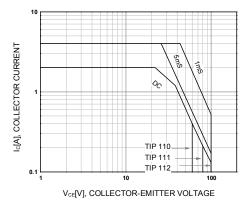


Figure 5. Safe Operating Area

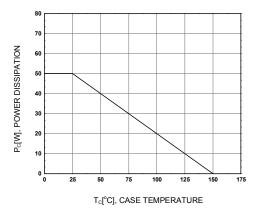
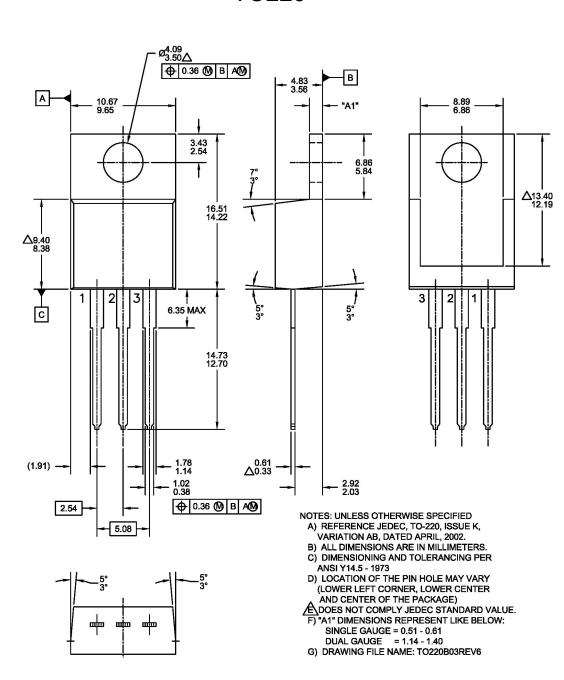


Figure 6. Power Derating

Mechanical Dimensions

TO220







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